

# FDP036N10A N-Channel PowerTrench<sup>®</sup> MOSFET 100V, 176A, 3.6mΩ

## Features

- $R_{DS(on)} = 3.2m\Omega$  (Typ.)@  $V_{GS} = 10V$ ,  $I_D = 75A$
- · Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant



# Description

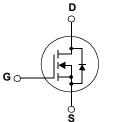
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

# Application

• DC to DC Convertors / Synchronous Rectification



**FDP Series** 



# MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol		Parameter		Ratings	Units	
V <sub>DSS</sub>	Drain to Source Voltage	Source Voltage			V	
V <sub>GSS</sub>	Gate to Source Voltage	Gate to Source Voltage		±20	V	
ID		- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C, Silicor	n Limited)	176*		
	Drain Current	- Continuous (T <sub>C</sub> = 100°C, Silice	on Limited)	125*	Α	
		- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C, Packa	age Limited)	120		
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	704	A	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	558	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	6.0	V/ns	
P <sub>D</sub>	Dewer Dissignation	$(T_{C} = 25^{\circ}C)$		227	W	
	Power Dissipation	- Derate above 25 <sup>o</sup> C		1.5	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

\*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120A.

## **Thermal Characteristics**

Symbol	Parameter Rati		Units
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	0.66	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	62.5	°C/W

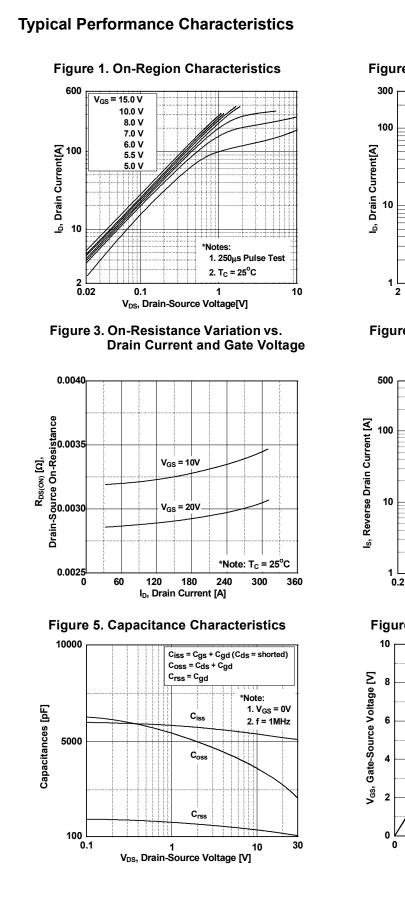
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**July 2010** 

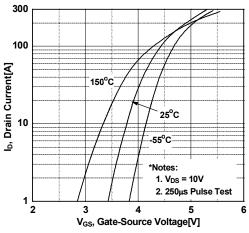
Device wi	Device Marking Devi		Packag	e	Reel Size	Тар	e Width	Quantity		у
		TO-220	)	-		-		50		
Electrica	l Char	acteristics T <sub>c</sub> =	25°C unless	otherwise	noted					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Units	
Off Charac	cteristic	s								
BV <sub>DSS</sub>		Source Breakdown V	oltage	lp = 250	$A V_{00} = 0 V T_0$	= 25°C	100	-	-	V
ABV <sub>DSS</sub>		own Voltage Temperati	0	$I_D = 250 \mu A, V_{GS} = 0V, T_C = 25^{\circ}C$					-	
$\Delta T_{J}$	Coefficie			$I_{\rm D} = 250$	uA, Referenced to	25°C	-	0.07	-	V/°C
1	Zero Gate Voltage Drain Current		ont	V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V		-	-	1		
DSS			ent	V <sub>DS</sub> = 80	)V, T <sub>C</sub> = 150 <sup>o</sup> C		-	-	500	μA
GSS	Gate to	Body Leakage Curren	ıt	$V_{GS} = \pm 2$	20V, V <sub>DS</sub> = 0V		-	-	±100	nA
On Charac	teristic	S								
V <sub>GS(th)</sub>	1	nreshold Voltage		$V_{CS} = V$	<sub>DS</sub> , I <sub>D</sub> = 250μA		2.0	3.0	4.0	V
R <sub>DS(on)</sub>		rain to Source On Res	sistance		DV, I <sub>D</sub> = 75A		-	3.2	3.6	mΩ
9 <sub>FS</sub>		d Transconductance			)V, I <sub>D</sub> = 75A	(Note 4)	-	167	-	S
	haracte	rictice		00						
	Amic Characteristics						5485	7295	۳E	
C <sub>iss</sub>	-	Capacitance				-	2430	3230	pF pF	
C <sub>oss</sub>		e Transfer Capacitance		f = 1MH:	MHz		-	2430	3230	pF pF
C <sub>rss</sub>			;				-	89	116	nC
Q <sub>g(tot)</sub>		ate Charge at 10V Source Gate Charge					-	24	110	nC
Q <sub>gs</sub>		harge Threshold to Pla	toou		V <sub>DS</sub> = 80V, I <sub>D</sub> = 75A V <sub>GS</sub> = 10V		-	8	-	nC
Q <sub>gs2</sub>		\$	leau	VGS - 10V		-	25	-	nC	
Q <sub>gd</sub>		Drain "Miller" Charge					-	25	-	ne
Switching				1					1	
d(on)		n Delay Time		$V_{DD} = 50V, I_D = 75A$ 			-	22	54	ns
t <sub>r</sub>		n Rise Time				-	54	118	ns	
d(off)		f Delay Time				-	37	84	ns	
f		f Fall Time				-	11	32	ns	
ESR	Equivale	ent Series Resistance	(G-S)			-	1.2	-	Ω	
Drain-Sou	rce Dioc	de Characteristic	S							
s	Maximu	m Continuous Drain to	Source Diode	de Forward Current		-	-	176	Α	
SM	Maximu	m Pulsed Drain to Sou	rce Diode For	orward Current		-	-	704	Α	
V <sub>SD</sub>	Drain to	Source Diode Forward	d Voltage	$V_{GS} = 0$	/, I <sub>SD</sub> = 75A		-	-	1.25	V
		Recovery Time			/, I <sub>SD</sub> = 75A		-	72	-	ns
n 2 <sub>rr</sub>	Reverse	se Recovery Charge		dI <sub>F</sub> /dt = 100A/μs		-	129	-	nC	

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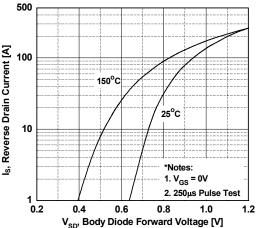


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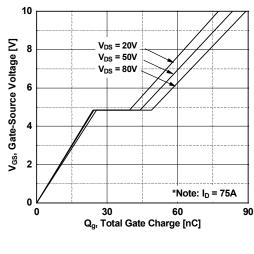
## Figure 2. Transfer Characteristics



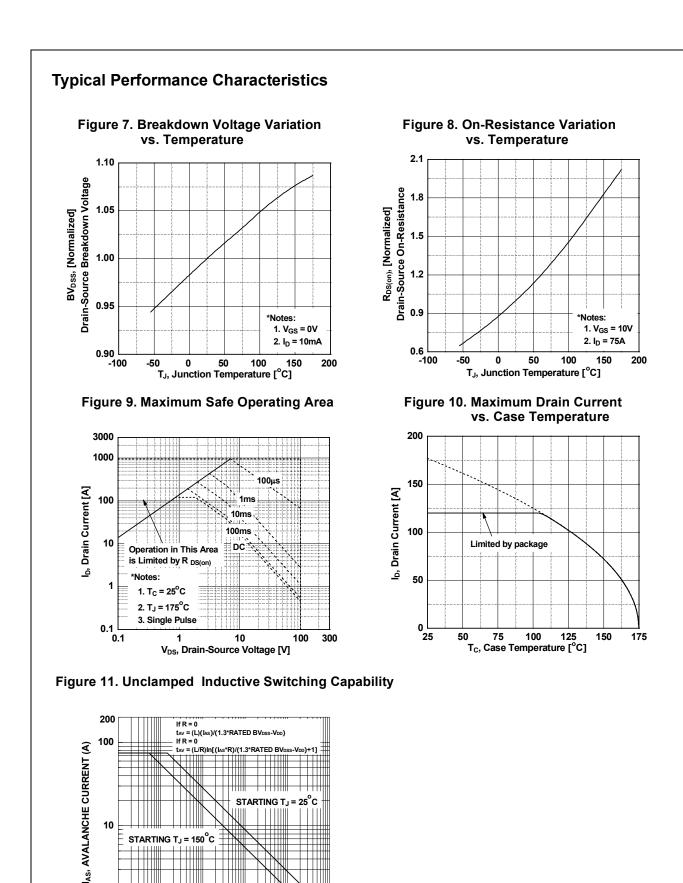








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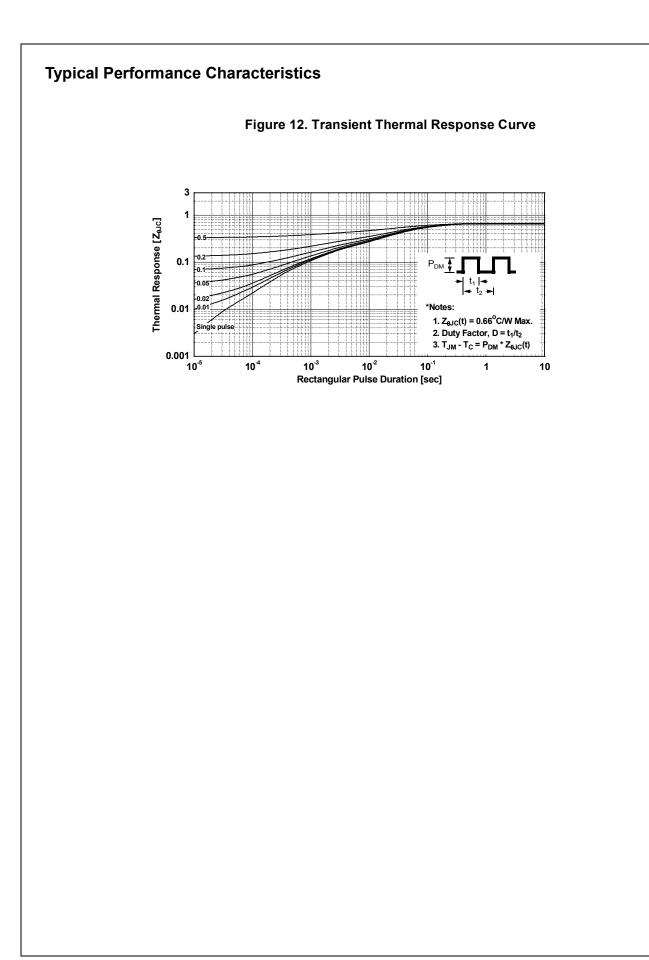
0.1

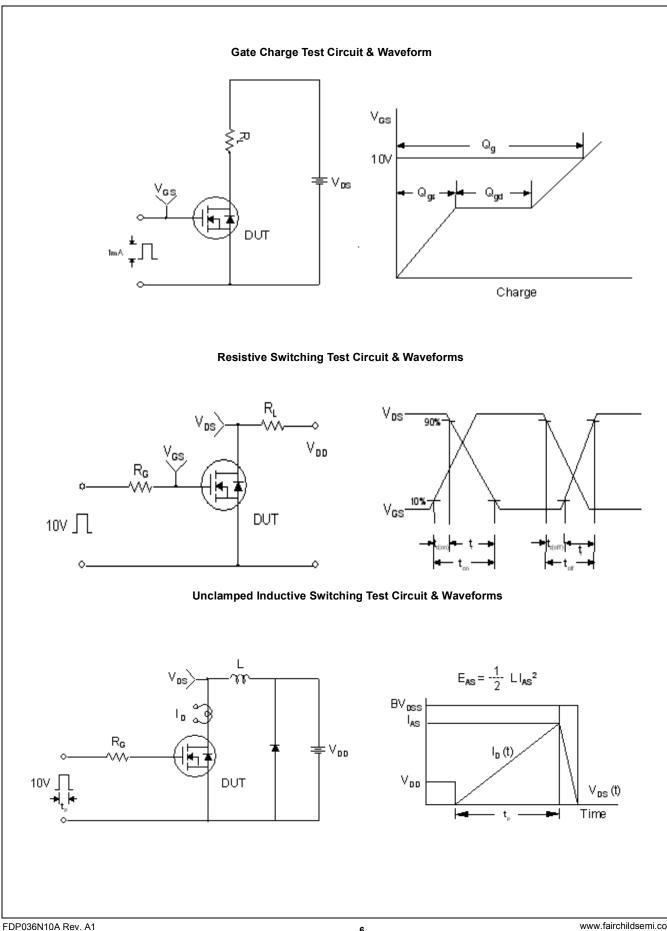
1 t<sub>AV</sub>, TIME IN AVALANCHE (ms)

10

100

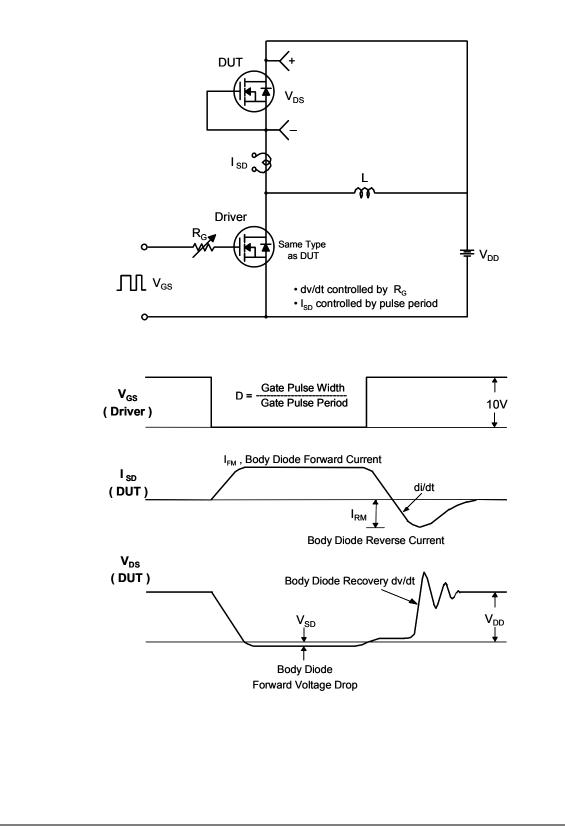
1000





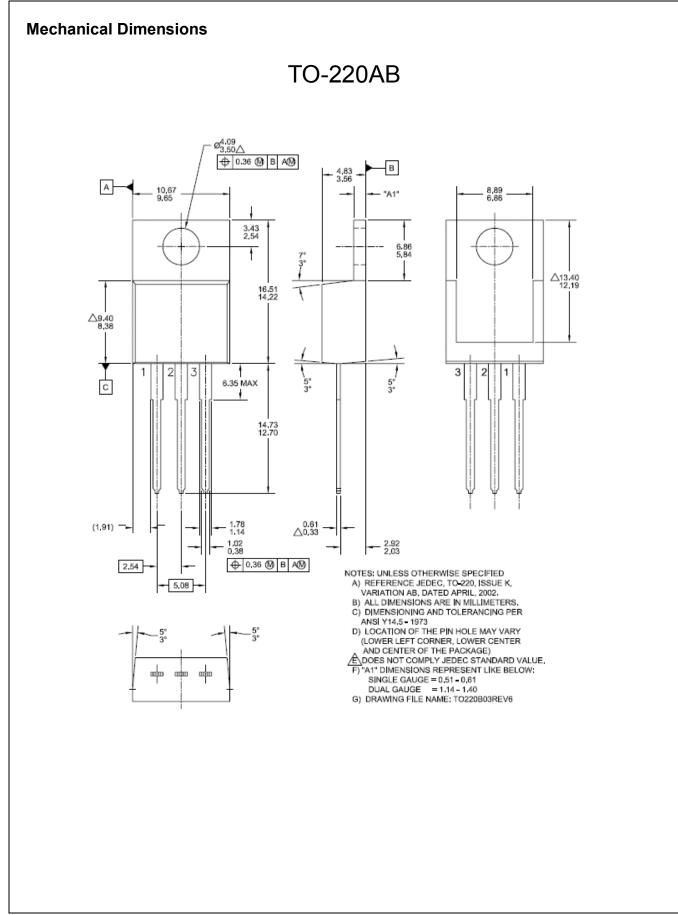
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Peak Diode Recovery dv/dt Test Circuit & Waveforms



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